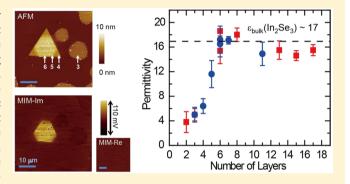


Thickness-Dependent Dielectric Constant of Few-Layer In₂Se₃ **Nanoflakes**

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Supporting Information

ABSTRACT: The dielectric constant or relative permittivity (ε_r) of a dielectric material, which describes how the net electric field in the medium is reduced with respect to the external field, is a parameter of critical importance for charging and screening in electronic devices. Such a fundamental material property is intimately related to not only the polarizability of individual atoms but also the specific atomic arrangement in the crystal lattice. In this Letter, we present both experimental and theoretical investigations on the dielectric constant of few-layer In₂Se₃ nanoflakes grown on mica substrates by van der Waals epitaxy. A nondestructive microwave impedance microscope is employed to simulta-



neously quantify the number of layers and local electrical properties. The measured ε_r increases monotonically as a function of the thickness and saturates to the bulk value at around 6-8 quintuple layers. The same trend of layer-dependent dielectric constant is also revealed by first-principles calculations. Our results of the dielectric response, being ubiquitously applicable to layered 2D semiconductors, are expected to be significant for this vibrant research field.

KEYWORDS: Microwave impedance microscopy, layer-dependent dielectric constant, In_2Se_3 nanoflakes, layered materials, polarization, first-principles calculations

The rapid rise of graphene in the past decade has led to an active research field on two-dimensional (2D) layered materials. 1,2 Of particular interest here are layered semiconductors, such as many metal chalcogenides, for their roles as gate dielectrics or channel materials in next-generation electronics.³ Because of the strong intralayer covalent bonding and weak van der Waals (vdW) interactions, most physical properties are already anisotropic in the bulk form, with a clear 3D-2D crossover when approaching the monolayer thickness. In particular, the number of layers (n) in a thin-film 2D system is expected to strongly influence its dielectric constant, a fundamental electrical property that determines the capacitance and charge screening in electronic devices. 4-6

The 2D material in this study is the layered semiconducting chalcogenide In₂Se₃, a technologically important system for phase-change memory, thermoelectric, and photoelectric applications. The In-Se phase diagram is among the most complex ones in binary compounds. Even at the exact stoichiometry of In:Se = 2:3, multiple phases can occur under different temperatures and pressures. 8-11 By controlling the synthesis parameters or thermal/electrical pretreatment processes, several phases (superlattice, simple hexagonal α -phase, simple hexagonal β -phase, and amorphous state) with vastly

different electrical conductivity can coexist at the ambient condition, ^{12–14} which explains the research interest of In₂Se₃ as a prototypical phase-change material.^{7,12–18} In addition, the lattice constant of In₂Se₃ matches well with Bi₂Se₃, which is heavily investigated for its high thermoelectric figure-of-merit and topological insulator nature. 19,20 The chemical and structural compatibility between the two chalcogenides enables the growth of In₂Se₃/Bi₂Se₃ heterostructures. ^{21,22} For all aforementioned applications, the dielectric constant of fewlayer In₂Se₃ is an important physical parameter that must be fully characterized as a function of n. We further emphasize that although In₂Se₃ is used as a model system in this work, neither the experimental technique nor the theoretical analysis is limited to this particular system, and the conclusions presented here are generally applicable for the fast growing field of 2D vdW materials.

The few-layer In₂Se₃ nanoflakes were grown by van der Waals epitaxy on mica substrates, 23 as schematically shown in Figure 1a. Detailed growth parameters and characterizations of the structural and electrical properties can be found in ref 23.

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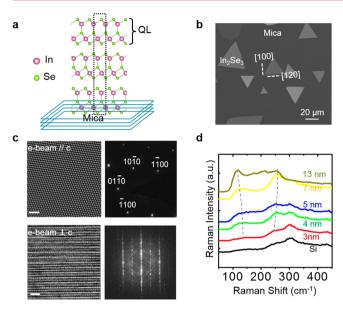


Figure 1. (a) Schematic of the few-layer In_2Se_3 sample on the mica substrate. Each quintuple layer (QL) comprises five atomic Se–In–Se–In–Se layers. The interlayer distance between layers is 2.87 Å in the z-direction. For the R3m lattice, the unit cell consists of three layers and is enclosed by the dashed box in the center. (b) SEM image of a typical discrete In_2Se_3 flakes on mica. (c) HRTEM images (left panel) and corresponding selected area electron diffraction (SAED, right-up) and fast Fourier transform (FFT, right-down) patterns of ||c-axis and $\perp c$ -axis. (d) Raman spectra of In_2Se_3 flakes with different thicknesses transferred onto SiO_2 (300 nm)/Si substrates.

When the sample was rapidly cooled down (>100 °C/min) from the deposition temperature, a superlattice phase can be observed by transmission electron microscopy (TEM), 12,13,23 which exhibits metallic behaviors with a high conductivity on the order of 10^5 S/m. At much slower cooling rates (<5 °C/min), on the other hand, the simple hexagonal lattice was obtained, showing the usual semiconducting behavior with a room-temperature conductivity of $10^{-2} - 10^{-3}$ S/m. 23 In this work, we have carefully controlled the growth conditions and screened the samples such that only the semiconducting α -phase In_2Se_3 was studied. No thermal pretreatment has been applied to the as-grown samples so neither β -phase nor amorphous phase was involved. Different batches of samples were measured, with no discernible difference with respect to each other.

Figure 1b shows a typical scanning electron microscopy (SEM) image of as-grown In₂Se₃ flakes on mica. Most flakes are triangular or hexagonal in shape, while some thin pieces $(n \le 3)$ are rounded at the corners. High-resolution transmission electron microscopy (HRTEM) was carried out to image the [001] in-plane lattice fringes and [100], [120] cross sections, which were obtained by cutting the samples along and perpendicular to one side of a triangle (dashed lines in Figure 1b), respectively. As shown in Figure 1c and Supporting Information Figure S1, the crystal symmetry along the [001] projection is P3m1, while the P1 and Pm symmetries along [100] and [120] directions give rise to specific electron diffraction or FFT patterns, suggesting that In₂Se₃ has the R3m structure. Although multiple phases were observed in previous work, 13,19 extensive TEM images reveal that the as-grown samples in this study are predominantly α -phase with the R3m space group, which is also confirmed by the Raman spectra in

Figure 1d. Two vibrational modes, E and A_1 , can be observed at around 144 and 237 cm⁻¹.²⁴ Similar to MoS_2 , the E mode shows a red-shift and the A_1 mode exhibits a blue-shift as the thickness increases from 3 to 13 nm. The experimental details are further described in the Methods section.

A microwave impedance microscope (MIM) based on the atomic force microscopy (AFM) platform ^{13,26–28} was employed to measure the thickness and dielectric response of fewlayer In₂Se₃ flakes, as illustrated in Figure 2a. During the

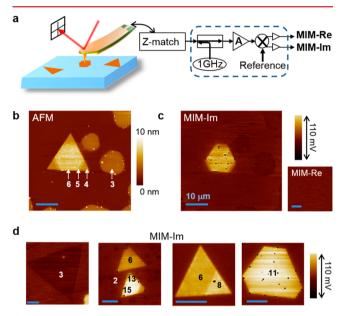


Figure 2. (a) Schematic of the simultaneous AFM and MIM measurements. (b) Topographic and (c) MIM-Im/Re images of the few-layer In_2Se_3 nanoflakes. The number (n) of layers is indicated in the AFM image. (d) More MIM-Im data on two batches of samples (see text). n is labeled for each terrace on the sample. All scale bars are $10~\mu m$ in the images.

contact-mode AFM scans, an excitation signal at 1 GHz is delivered to the tip, and the reflected wave is detected by the microwave electronics to form the imaginary (MIM-Im) and real (MIM-Re) components of the MIM output. Because the relevant tip and sample dimensions are much smaller than the free-space wavelength (λ = 30 cm) at 1 GHz, the extreme nearfield interaction can be modeled as a lumped-element circuit, from which the local dielectric constant and conductivity of the sample can be deduced.²⁷

Figures 2c and 2d show the simultaneously taken topography and MIM images of several In₂Se₃ nanoflakes. Aside from some insulating particles (bright in AFM and dark in MIM-Im), both the In₂Se₃ flakes and the mica substrate are atomically flat, confirming the layered vdW characteristics. Since each Se-In-Se-In-Se quintuple layer is about 1 nm thick, ²³ which was also confirmed by the AFM measurements (Figure S2), the different terraces of the sample in Figure 2c can be designated as n from 3 to 6. Interestingly, the corresponding MIM-Im image shows distinct contrast over the mica substrate as a function of the flake thicknesses. For n = 2 or 3, the MIM signal on the flake is lower than that on the substrate, indicating that the dielectric constant of ultrathin In_2Se_3 is smaller than $\varepsilon_{r,mica} \approx 6.^{29}$ On the other hand, the regions of the flake with n = 4 are hardly seen over the background, while the five-layer section is clearly visible. For thicker flakes with $n \ge 6$, the MIM-Im signals are well above that of the mica substrate, consistent with the

relatively large bulk In_2Se_3 dielectric constant of $\varepsilon_r=17.^{30}$ The same trend was observed in other flakes, as enumerated in Figure 2d. The complete set of AFM and MIM images can be found in Figure S3. For all nanoflakes we measured, no signal above the noise level was detected in the MIM-Re channel, suggesting that the MIM signal is purely due to permittivity contrast over the mica substrate rather than the negligible conductivity in the as-grown α -phase In_2Se_3 .

Quantitative analysis of the AFM/MIM data is shown in Figure 3. From the linear fit of the AFM data (Figure S2), the

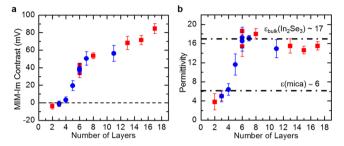


Figure 3. (a) MIM-Im contrast as a function of *n*. The dashed line is a guide to the eyes. (b) Permittivity deduced from MIM-Im as a function of *n*. The blue circles and red squares represent two different batches of samples.

thickness of a single In₂Se₃ quintuple layer is about 1.02 nm. The MIM-Im signals, however, show a clear downward kink at around six layers when approaching the monolayer limit. To understand the results, we performed numerical simulations using a finite-element analysis (FEA) software COMSOL4.4,²⁶ and the details are included in Figure S4. Because of the axisymmetric quasi-static electric field around the tip apex, we can only obtain the effective isotropic $\varepsilon_{\rm r,eff}$ rather than separately determine the in-plane and out-of-plane dielectric constants in In₂Se₃. As demonstrated in Figure 3b, within the experimental errors, the effective dielectric constant increases monotonically from 2 to 6 layers and saturates to the bulk value after n = 8. We emphasize that while a similar thicknessdependent dielectric constant in MoS2 has been recently reported by parallel-plate experiments,³¹ the MIM approach is noninvasive to the materials so that as-grown samples can be measured without patterning any contact electrodes.

To further understand the thickness dependence of the macroscopic ε_r , we carried out first-principles calculations using density functional theory (DFT) with the Heyd-Scuseria-Ernzerhof hybrid functional (HSE06).32 Here, we only considered free-standing QLs of In₂Se₃ as a model system and calculated the electronic contribution to permittivity (i.e., $arepsilon^{\infty}$ or the so-called ion-clamped dielectric constant) in order to understand the role of interlayer interactions on $\varepsilon_{\rm r}$. Note that $arepsilon^{\infty}$ underestimates the static $arepsilon_{\mathrm{r}}$ by the portion of the ionic contribution but is sufficient to reveal important trends in the thickness-dependent behavior. Each QL slab was modeled in the R3m space group, containing In atoms in both tetrahedral and octahedral sites; 8,31,33 note that the QLs are stacked in the AB fashion, as described in the Methods section and depicted in Figure 4b. Figure 4a shows the calculated variation of the inplane $\varepsilon_{xy}^{\infty}$ ($\varepsilon_x^{\infty} = \varepsilon_y^{\infty}$) and out-of-plane ε_z^{∞} as n increases, indicating that ε^{∞} monotonically increases as In_2Se_3 transitions from the monolayer to the bulk crystal. Such thickness dependent behavior is consistent with that predicted for transition metal dichalcogenides. 5,34,35 This result suggests that

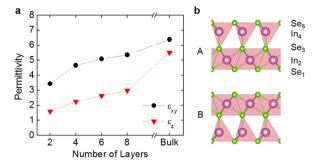


Figure 4. (a) Ion-clamped dielectric permittivity parallel (ε_z) and perpendicular (ε_{xy}) to the *c*-axis predicted from DFT-HSE06 calculations for varying number of QLs of In₂Se₃. (b) Representative schematic of the 2 QL case to demonstrate the use of inverted layering (i.e., A is a mirror of B). Purple and green balls represent In and Se atoms, respectively, while pink polyhedra indicate tetrahedral and octahedral sites. The numeric labels for Se and In are described in the text.

the intrinsic polarizability within the QLs tends to increase with n. In addition, we find that ε^{∞} exhibits clear anisotropy that is lower in the direction perpendicular to the QL surface (i.e., c-axis), which is consistent with other 2D materials. 5,34,35

The Born effective (dynamical) charge tensor (Z_{α}^*) along principal directions α was calculated to further analyze the local dipole moment behavior. Z_{α}^* is a measure of the macroscopic current and spontaneous polarization that result from the displacement of ions. A summary of the computed in-plane Z_{xy}^* and cross-plane Z_z^* for the bulk and n=2 cases can be found in Table 1, following the naming convention from Figure

Table 1. Born Effective Charges (Z_{α}^*) for Species within One QL of Bilayer (n = 2) and Bulk In_2Se_3

	$Z_{xy}^* (n=2)$	Z_{xy}^* (bulk)	$Z_z^* \ (n=2)$	Z_z^* (bulk)
Se_1	-2.54	-2.54	-0.25	-0.66
In_2	4.04	4.02	0.45	1.60
Se_3	-1.81	-1.81	-0.46	-1.75
In_4	2.81	2.79	0.57	1.79
Se ₅	-2.50	-2.49	-0.30	-0.94

4b. First, we note that Z_{xy}^* tends to be close (within 35%) to the nominal charges of Se (-2) and In (+3), indicating limited in-plane charge transfer in response to an external field. In addition, Z_{xv}^* remains effectively the same in the n=2 and the bulk cases. However, a clear anisotropy is present in which $|Z_z^*|$ < $|Z_{xv}^*|$. In fact, the magnitude of Z_z^* exhibits a large suppression with respect to the nominal charges (as much as 85%) that is increasingly repressed as n decreases, suggesting the induction of a local dipole in the out-of-plane direction that is consistent with the anisotropic ε^{∞} shown in Figure 4a. Interestingly, this behavior is fundamentally different from 3D crystalline materials, such as perovskites that typically exhibit anomalously large Z^* ; in these cases, the large Z^* is attributed to the covalence between anion and cation atoms. ^{36–38} Instead, our results show that due to the layered nature of In₂Se₃, the suppression in Z_z^* is most (least) apparent in the outer Se_1/Se_2 (inner Se₃) atoms which are under (fully) coordinated. Moreover, the presence of the weak Se-Se interlayer interaction in the bulk case tends to improve the cross-plane polarizability (i.e., increase Z_z^* and approach the nominal charges).

This analysis demonstrates the sensitivity of the dielectric properties to the interlayer interactions. On the other hand, we note that the experimental data show a more abrupt increase of $\varepsilon_{\rm r}$ around n=4-6 than that predicted by the theoretical calculations. One factor we did not include in the model systems is the possible interaction between the QLs and the mica substrate, which may strongly influence $\varepsilon_{\rm r}$ when n is small according to our hypothesis. Therefore, it may be insightful to explore ${\rm In_2Se_3}$ on different substrates to further understand the role of the substrate–QL interaction with respect to QL–QL interactions on its optical properties.

In summary, we have observed a layer-dependent dielectric constant of few-layer In_2Se_3 nanoflakes via the MIM technique. The dielectric constant of In_2Se_3 rises monotonically as the layer number increases from 2 to 6 and approaches the bulk value beyond n=6. First-principles calculations suggest that the smaller dielectric constant of few-layer flakes results from the suppression of cross-plane polarization, a specific feature of layered materials, which can be strongly influenced by interlayer interactions. Our finding is not only significant for fundamental research but also beneficial for multifunctional nanoelectronics based on the tunable dielectric constant of 2D materials.

Methods. Growth of In_2Se_3 . The van der Waals epitaxy growth of semiconducting In_2Se_3 flakes on fluorophlogopite mica was carried out in a horizontal tube furnace (Lindberg Blue MHTF55667C) equipped with a 1 in. diameter quartz tube. The In_2Se_3 powder source (99.99%, Alfa Aesar) was placed at the hot center of the tube furnace heated to 690–750 °C. The vapor was carried downstream by 30–200 sccm Ar gas, and In_2Se_3 flakes were deposited on the substrate 7–12 cm away from heating center.

Raman Spectrum Measurements. Raman spectroscopy was carried out using Witec Alpha 300 micro-Raman confocal microscope and a laser operating at wavelength of 488 nm. To avoid the Raman peaks of mica substrate, we transferred the $\rm In_2Se_3$ from mica to $\rm SiO_2$ (300 nm)/Si substrate using the method which transfers graphene and other 2D materials.²³

Microwave Impedance Microscopy Measurements. The MIM in this work is based on an AFM platform (ParkAFM XE-70). The customized shielded cantilevers are commercially available from PrimeNano Inc.²⁸ Finite-element analysis was performed using the commercial software COMSOL4.4.

Density Functional Theory Calculations. The ground-state geometries and static dielectric constants were calculated using DFT within the HSE06 generalized gradient approximation, 32,39 as implemented in the Vienna Ab-initio Simulation Package (VASP). The projector augmented wave method 41,42 was employed to describe the interaction between the core and valence electrons using a plane-wave basis set with a cutoff of 400 eV. Dispersion corrections were included using the semiempirical DFT-D2 method from Grimme. All Brillouin zone integrations were sampled using a (4 × 4 × 1) Γ-centered Monkhorst–Pack k-point scheme.

Each QL was modeled as part of the R3m space group (no. 160). The bulk crystal was modeled using two formula units (Z=2) with $\sigma_{\rm v}$ symmetry (see Figure 4b); the layer inversion was required to remove spurious polarization effects in the slab supercells, thereby limiting n to even integers. The geometric optimization of the bulk crystal was performed until the Hellmann–Feynman forces converged to less than 0.02 eV/Å; the lattice constants were found to be a=3.987 Å and c=21.126 Å with an interlayer distance (Se–Se) of 3.65 Å. For the n=2,4,6, and 8 cases, further optimization did not noticeably

alter the atomic positions; a vacuum spacing of 27 Å was included in the z-direction to minimize interactions with periodic images. The static dielectric constants and Born effective charge tensors were computed based on linear response theory under finite electric fields (= 0.005 eV/Å) which was implemented in VASP. 45

ASSOCIATED CONTENT

S Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acs.nanolett.5b03575.

Complete AFM and MIM images of In₂Se₃ nanoflakes, thickness fitting of different layers, detailed finite-element simulation, and the inhomogeneous MIM images of 4–5 layered In₂Se₃ (PDF)

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D.W. and A.P. contributed equally to this work.

Notes

The authors declare no competing financial interest.

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